# **1-Channel ESD Protection Device in 0201 CSP**

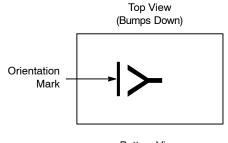
#### **Description**

The CM1242–33CP is a 2-bump ESD protection device in 0201 CSP form factor. It is fully compliant with IEC 61000–4–2. The CM1242–33CP is also RoHS II compliant and has a pure tin finish.

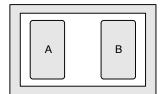
**Table 1. PIN DESCRIPTIONS** 

Pin	Description	
Α	ESD Channel Pin 1	
В	ESD Channel Pin 2	

#### **PACKAGE / PINOUT DIAGRAMS**



Bottom View (Bumps Up)





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WLCSP2 CP SUFFIX CASE 567AV

#### **BLOCK DIAGRAM**



#### **MARKING DIAGRAM**



Y = Specific Device Code

#### **ORDERING INFORMATION**

Device	Package	Shipping
CM1242-33CP	CSP (Pb-Free)	10,000/Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specification Brochure, BRD8011/D.

#### **SPECIFICATIONS**

**Table 2. STANDARD OPERATING CONDITIONS** 

Parameter	Rating	Units
Storage Temperature Range	-55 to +150	°C
Operating Temperature Range	-40 to +85	°C
Maximum Input Voltage	±5.5	V

# Table 3. ELECTRICAL OPERATING CHARACTERISTICS (Note 1)

Symbol	Parameter	Conditions	Min	Тур	Max	Units
V <sub>B</sub>	Breakdown Voltage	I <sub>F</sub> = +10 mA I <sub>F</sub> = -10 mA	6.0 -9.0	7.6 -7.6	9.0 -6.0	V
I <sub>LEAK</sub> Channel Leakage Current		V <sub>IN</sub> = ±3.3 V		±0.1	±0.5	μΑ
C <sub>IN</sub>	Channel Input Capacitance	At 1 MHz, V <sub>IN</sub> = 0 V	45	55	66	pF
V <sub>ESD</sub>	ESD Protection Peak Discharge Voltage at any channel input a) Contact Discharge per IEC 61000-4-2 standard b) Air Discharge per IEC 61000-4-2 standard	(Note 2)	±30 ±30			kV
V <sub>CL</sub> Channel Clamp Voltage Positive Transients Negative Transients		$I_{PP} = 1 \text{ A, } t_p = 8/20  \mu\text{s}$		+8.6 -8.6		V
R <sub>DYN</sub>	Dynamic Resistance Positive Transients Negative Transients	$I_{PP} = 1 \text{ A, } t_p = 8/20  \mu \text{s}$		0.4 0.4		Ω

T<sub>A</sub> = 25°C unless otherwise specified.
 Standard IEC 61000–4–2 with C<sub>Discharge</sub> = 150 pF, R<sub>Discharge</sub> = 330 Ω.

#### **MECHANICAL SPECIFICATIONS**

# CM1242-33CP Mechanical Specifications

The CM1242-33CP is supplied in a 2-bump Chip Scale Package (CSP). Dimensions are presented below.

#### **Table 4. CSP TAPE AND REEL SPECIFICATIONS**

Part Number	Chip Size (mm)	Pocket Size (mm) B <sub>0</sub> X A <sub>0</sub> X K <sub>0</sub>	Tape Width W	Reel Diameter	Qty per Reel	P <sub>0</sub>	P <sub>1</sub>	
CM1242-33CP	0.60 X 0.30 X 0.275	0.67 X 0.37 X 0.35	8 mm	178 mm (7")	10,000	4 mm	2 mm	

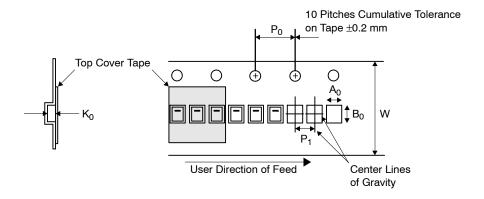
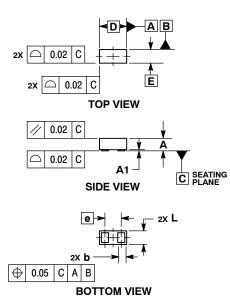


Figure 1. Tape and Reel Mechanical Data

#### PACKAGE DIMENSIONS

WLCSP2, 0.6x0.3 CASE 567AV-01 ISSUE O



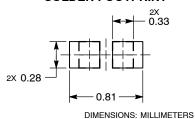
#### NOTES:

- DIMENSIONING AND TOLERANCING PER
- ASME Y14.5M, 1994.
  2. CONTROLLING DIMENSION: MILLIMETERS.

	MILLIMETERS		
DIM	MIN	MAX	
Α	0.25	0.30	
A1	0.00	0.05	
b	0.14	0.17	
D	0.60 BSC 0.30 BSC		
Е			
е	0.36 BSC		
L	0.19	0.24	

# RECOMMENDED SOLDER FOOTPRINT\*

Mounting Techniques Reference Manual, SOLDERRM/D.



\*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and

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CM1242-33CP/D